

Data sheet acquired from Harris Semiconductor SCHS098D - Revised October 2003

# CD40107B Types

# **CMOS Dual 2-input** NAND Buffer/Driver

High-Voltage Type (20-Volt Rating)

The CD40107B is a dual 2-input NAND buffer/driver containing two independent 2-input NAND buffers with open-drain single n-channel transistor outputs. This device features a wired-OR capability and high output sink current capability (136 mA typ. at  $V_{\mbox{DD}}$  = 10 V,  $V_{\mbox{DS}}$  = 1 V). The CD40107B is supplied in 8-lead hermetic dual-in-line ceramic packages (F3A suffix), 8-lead dual-in-line plastic packages (E suffix), 8-lead small-outline packages (M, M96, MT, and PSR suffixes), and 8-lead thin shrink small-outline packages (PW and PWR suffixes).

#### Features:

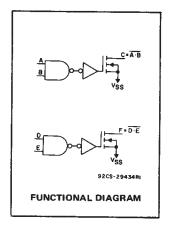
- 32 times standard B-Series output current drive sinking capability - 136 mA typ. @ VDD = 10 V, VDS = 1 V
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- 5-V, 10-V, and 15-V parametric ratings
- Noise margin, full package temperature range, R<sub>L</sub> to V<sub>DD</sub> = 10 k $\Omega$ :

1 V at V<sub>DD</sub> = 5 V

2 V at V<sub>DD</sub> = 10 V

2.5 V at V<sub>DD</sub> = 15 V

\* Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



#### **Applications**

- Driving relays, lamps, LEDs
- Line driver
- Level shifter (up or down)

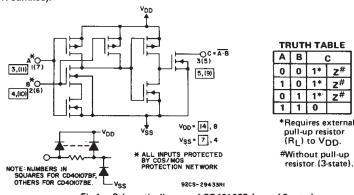


Fig.1 - Schematic diagram of CD40107B (one of 2 gates)

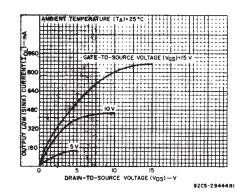


Fig.2 - Typical output low (sink) current characteristics.

#### MAXIMUM RATINGS, Absolute-Maximum Values:

At distance 1/16  $\pm$  1/32 inch (1.59  $\pm$  0.79mm) from case for 10s max ...... +265°C

#### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC                  | LII  |      |       |
|---------------------------------|------|------|-------|
| CHARACTERISTIC                  | MIN. | MAX. | UNITS |
| Supply-Voltage Range (For TA=   |      |      |       |
| Full Package-Temperature Range) | 3    | 18   | V     |

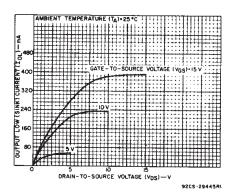


Fig.3 - Minimum output low (sink) current characteristics.

#### CD40107B Types

### DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^{\circ}$ C, $C_L = 50$ pF, input $t_r, t_f = 20$ ns

|                                  | TEST CONDIT              | TIONS                    | LIN  |      |       |  |
|----------------------------------|--------------------------|--------------------------|------|------|-------|--|
| CHARACTERISTIC                   |                          | V <sub>DD</sub><br>Volts | Тур. | Max. | UNITS |  |
| Propagation Delay:               |                          | 5                        | 100  | 200  |       |  |
| High-to-Low, tpHL                | R <sub>L</sub> * = 120 Ω | 10                       | 45   | 90   | ns    |  |
|                                  |                          | 15                       | 30   | 60   |       |  |
| Low-to-High, tpLH                |                          | 5                        | 100  | 200  |       |  |
|                                  | RL* = 120 Ω              | 10                       | 60   | 120  | ns    |  |
|                                  |                          | 15                       | 50   | 100  |       |  |
| Transition Time:                 |                          | 5                        | 50   | 100  | ns    |  |
| High-to-Low, tTHL                | RL* = 120 Ω              | 10                       | 20   | 40   |       |  |
|                                  |                          | 15                       | 10   | 20   |       |  |
|                                  |                          | 5                        | 50   | 100  |       |  |
| Low-to-High, tTLH                | RL* = 120 Ω              | 10                       | 35   | 70   | ns    |  |
|                                  |                          | 15                       | 25   | 50   | ]     |  |
| Average Input Capacitance, CIN   | Any Input                |                          | 5 .  | 7.5  | pF    |  |
| Average Output Capacitance, COUT | Any Output               |                          | 30   | _    | pF    |  |

<sup>\*</sup> R<sub>L</sub> is external pull-up resistor to V<sub>DD</sub>.

#### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-                                     | CONI         | LIMITS AT INDICATED TEMPERATURES (°C) |     |       |                            |     |      |      | UNITS             |      |    |
|--|--------------|---------------------------------------|-----|-------|----------------------------|-----|------|------|-------------------|------|----|
| 13110  | Vo           | VO VIN VDD                            |     |       |                            |     |      |      | +25               |      |    |
|  | (V)          | (V)                                   | (V) | -55   | <b>-40</b>                 | +85 | +125 | Min. | Тур.              | Max. |    |
| Quiescent Device                               | <del>-</del> | 0,5                                   | 5   | 1     | 1                          | 30  | 30   | _    | 0.02              | 1    |    |
| Current  | _            | 0,10                                  | 10  | 2     | 2                          | 60  | 60   | _    | 0.02              | 2    | ١. |
| IDD Max.                                       | _            | 0,15                                  | 15  | 4     | 4                          | 120 | 120  | _    | 0.02              | 4    | μΑ |
|  | _            | 0,20                                  | 20  | 20    | 20                         | 600 | 600  | _    | 0.04              | 20   |    |
| Output Low                                     | 0.4          | 0,5                                   | 5   | 21    | 20                         | 14  | 12   | 16   | 32                | _    |    |
| (Sink) Current                                 | 1            | 0,5                                   | 5   | 44    | 42                         | 30  | 25   | 34   | 68                | _    |    |
| IOL Min.                                       | 0.5          | 0,10                                  | 10  | 49    | 46                         | 32  | 28   | 37   | 74                | _    |    |
| -OL  | 1            | 0,10                                  | 10  | 89    | 85                         | 60  | 51   | 68   | 136               |      | mA |
|  | 0.5          | 0,15                                  | 15  | 66    | 63                         | 44  | 38   | 50   | 100               | -    |    |
| Output High<br>(Source)<br>Current<br>IOH Min. |              |                                       |     | No In | No Internal Pull-Up Device |     |      |      |                   |      |    |
| Input Low                                      | 4.5          | -                                     | 5   |       | 1                          | .5  |      | : -  | _                 | 1.5  |    |
| Voltage  | 9            | -                                     | 10  |       | ,                          | 3   |      | _    | -                 | 3    |    |
| VIL Max.*                                      | 13.5         | _                                     | 15  |       | 4                          | 1   |      | -    | _                 | 4    | v  |
| Input High                                     | 0.5,4.5      | _                                     | 5   |       | 3                          | .5  |      | 3.5  | _                 | _    | v  |
| Voltage  | 1,9          | _                                     | 10  |       |                            | 7   |      | 7    | _                 |      |    |
| VIH Min.*                                      | 1.5,13.5     | 1                                     | 15  |       | 11 11                      |     |      |      |                   | _    |    |
| Input Current IJN Max.                         |              | 0,18                                  | 18  | ±0.1  | ±0.1                       | ±1  | ±1   | -    | ±10 <sup>-5</sup> | ±0.1 | μΑ |
| Output Leakage<br>Current<br>IOZ Max.          | 18           | 0,18                                  | 18  | 2     | 2                          | 20  | 20   | -    | 10 <sup>-4</sup>  | 2    | μΑ |

<sup>\*</sup> Measured with external pull-up resistor, RL = 10 k $\Omega$  to VDD.

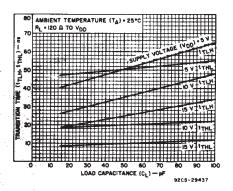


Fig.4 — Typical transition time as a function of load capacitance.

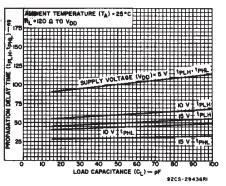


Fig.5 — Typical propagation delay time as a function of load capacitance.

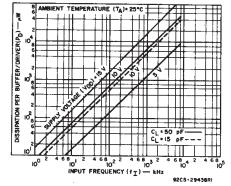


Fig.6 — Typical power dissipation as a function of input frequency.

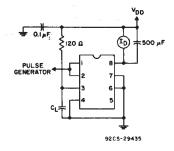
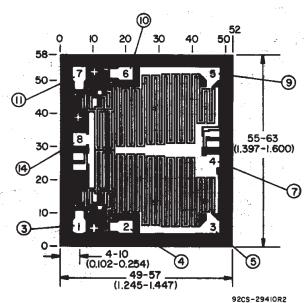


Fig. 7 — Power-dissipation test circuit for CD401078E.

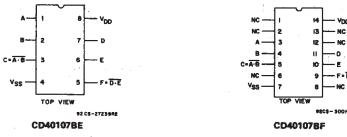
#### CD40107B Types



NOTE: NOS. IN PADS FOR CD40107BE NOS. OUTSIDE CHIP FOR CD40107BF

Dimensions and Pad Layout for CD401078H.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).



**TERMINAL ASSIGNMENTS** 

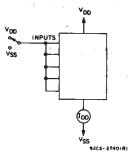


Fig.8 - Quiescent-device current test circuit.

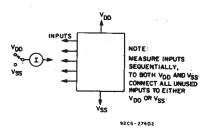


Fig. 9 - Input-current test circuit.

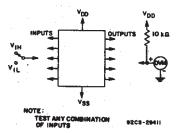


Fig. 10 — Input-voltage test circuit.

#### Special Considerations for CD40107B

Limiting Capacitive Currents for CL > 500 pF, V<sub>DD</sub> > 15 V.
 For V<sub>DD</sub> > 15 V, and load capacitance

For VDD > 15 V, and load capacitance (CL) from output to ground > 500 pF, an external 25  $\Omega$  series limiting resistor should be inserted between the output terminal and CL. No external resistor is necessary if CL < 500 pF or VDD < 15 V.

#### 2. Driving Inductive Loads

When using the CD40107B to drive inductive loads, the load should be shunted with a diode to prevent high voltages from developing across the CD40107B output.

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#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup>  | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| CD40107BE        | ACTIVE                | PDIP            | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD40107BEE4      | ACTIVE                | PDIP            | Р                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD40107BF        | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type           |
| CD40107BF3A      | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                        | A42 SNPB         | N / A for Pkg Type           |
| CD40107BM        | ACTIVE                | SOIC            | D                  | 8    | 75             | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BM96      | ACTIVE                | SOIC            | D                  | 8    | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BM96E4    | ACTIVE                | SOIC            | D                  | 8    | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BM96G4    | ACTIVE                | SOIC            | D                  | 8    | 2500           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BME4      | ACTIVE                | SOIC            | D                  | 8    | 75             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BMG4      | ACTIVE                | SOIC            | D                  | 8    | 75             | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BMT       | ACTIVE                | SOIC            | D                  | 8    | 250            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BMTE4     | ACTIVE                | SOIC            | D                  | 8    | 250            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BMTG4     | ACTIVE                | SOIC            | D                  | 8    | 250            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPSR      | ACTIVE                | SO              | PS                 | 8    | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPSRE4    | ACTIVE                | SO              | PS                 | 8    | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPSRG4    | ACTIVE                | SO              | PS                 | 8    | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPW       | ACTIVE                | TSSOP           | PW                 | 8    | 150            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPWE4     | ACTIVE                | TSSOP           | PW                 | 8    | 150            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPWG4     | ACTIVE                | TSSOP           | PW                 | 8    | 150            | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPWR      | ACTIVE                | TSSOP           | PW                 | 8    | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPWRE4    | ACTIVE                | TSSOP           | PW                 | 8    | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD40107BPWRG4    | ACTIVE                | TSSOP           | PW                 | 8    | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM           |

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



#### PACKAGE OPTION ADDENDUM

9-Oct-2007

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <a href="http://www.ti.com/productcontent">http://www.ti.com/productcontent</a> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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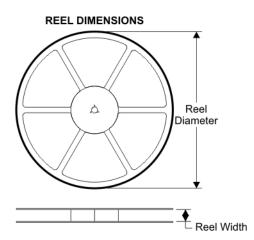
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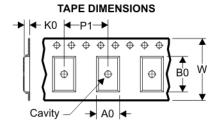




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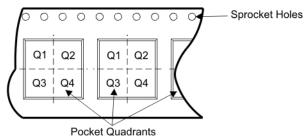
#### TAPE AND REEL BOX INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device      | Package | Pins | Site    | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|---------|------|---------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| CD40107BM96 | D       | 8    | SITE 27 | 330                      | 12                    | 6.4     | 5.2     | 2.1     | 8          | 12        | Q1               |
| CD40107BM96 | D       | 8    | SITE 41 | 330                      | 12                    | 6.4     | 5.2     | 2.1     | 8          | 12        | Q1               |
| CD40107BPSR | PS      | 8    | SITE 41 | 330                      | 16                    | 8.2     | 6.6     | 2.5     | 12         | 16        | Q1               |
| CD40107BPWR | PW      | 8    | SITE 41 | 330                      | 12                    | 7.0     | 3.6     | 1.6     | 8          | 12        | Q1               |





| Device      | Package | Pins | Site    | Length (mm) | Width (mm) | Height (mm) |
|-------------|---------|------|---------|-------------|------------|-------------|
| CD40107BM96 | D       | 8    | SITE 27 | 342.9       | 338.1      | 20.64       |
| CD40107BM96 | D       | 8    | SITE 41 | 346.0       | 346.0      | 29.0        |
| CD40107BPSR | PS      | 8    | SITE 41 | 346.0       | 346.0      | 33.0        |
| CD40107BPWR | PW      | 8    | SITE 41 | 346.0       | 346.0      | 29.0        |

### 14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

#### P (R-PDIP-T8)

#### PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg\_info.htm

# D (R-PDSO-G8)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

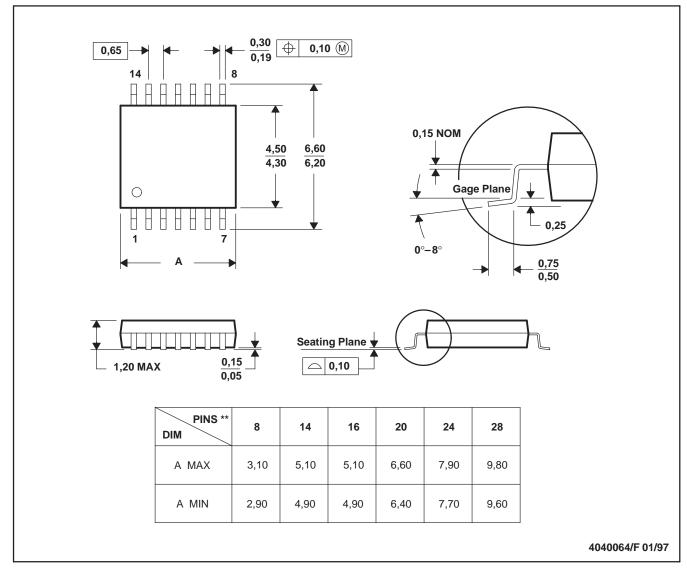
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153